



**CHENMKO ENTERPRISE CO.,LTD**

Halogens free devices

**SURFACE MOUNT  
NPN Switching Transistor**

**VOLTAGE 80 Volts CURRENT 1 Ampere**

**CHT3019XGP**

**APPLICATION**

- \* Telephony and professional communication equipment.
- \* Other switching applications.

**FEATURE**

- \* Suitable for high packing density.
- \* High saturation current capability.
- \* Voltage controlled small signal switch.

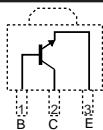
**CONSTRUCTION**

- \* NPN Switching Transistor

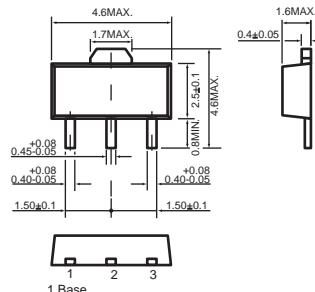
**MARKING**

XCN

**CIRCUIT**



**SC-62/SOT-89**



1 Base  
2 Collector ( Heat Sink )  
3 Emitter

Dimensions in millimeters

**SC-62/SOT-89**

**LIMITING VALUES**

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
$V_{CBO}$	collector-base voltage	open emitter	—	120	V
$V_{CEO}$	collector-emitter voltage	open base	—	80	V
$V_{EBO}$	emitter-base voltage	open collector	—	7.0	V
$I_C$	collector current (DC)		—	1000	mA
$I_{CM}$	peak collector current		—	1500	mA
$P_{tot}$	total power dissipation	$T_{amb} \leq 25^\circ\text{C}$ ; note 1	—	1.2	W
$T_{stg}$	storage temperature		-65	+150	$^\circ\text{C}$
$T_j$	junction temperature		—	150	$^\circ\text{C}$
$T_{amb}$	operating ambient temperature		-65	+150	$^\circ\text{C}$

**Note**

1. Transistor mounted on an FR4 printed-circuit board.

## RATING CHARACTERISTIC CURVES ( CHT3019XGP )

### THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
$R_{th\ j-a}$	thermal resistance from junction to ambient	note 1	357	K/W

**Note**

- Transistor mounted on an FR4 printed-circuit board.

### CHARACTERISTICS

$T_{amb} = 25^\circ C$  unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
$I_{CBO}$	collector cut-off current	$I_E = 0; V_{CB} = 90\ V$	–	10	nA
$I_{EBO}$	emitter cut-off current	$I_C = 0; V_{EB} = 5\ V$	–	10	nA
$h_{FE}$	DC current gain	$I_C = 0.1\ mA; V_{CE} = 10V$ $I_C = 1.0\ mA; V_{CE} = 10V$ $I_C = 150\ mA; V_{CE} = 10V$ $I_C = 500\ mA; V_{CE} = 10V$ $I_C = 1.0\ A; V_{CE} = 10V$	50 90 100 50 15	– – 300 – –	
$V_{CEsat}$	collector-emitter saturation voltage	$I_C = 150\ mA; I_B = 15\ mA$ $I_C = 500\ mA; I_B = 50\ mA$	– –	0.2 0.5	V
$V_{BEsat}$	base-emitter saturation voltage	$I_C = 150\ mA; I_B = 15\ mA$	–	1.1	V
$C_{ob}$	collector capacitance	$I_E = i_e = 0; V_{CB} = 1.0\ V; f = 1\ MHz$	–	12	pF
$C_{ib}$	emitter capacitance	$I_C = i_c = 0; V_{BE} = 500\ mV; f = 1\ MHz$	–	60	pF
$f_T$	transition frequency	$I_C = 50\ mA; V_{CE} = 1.0\ V; f = 1.0\ MHz$	100	–	MHz
F	noise figure	$I_C = 100\ \mu A; V_{CE} = 1.0\ V; R_S = 1\ k\Omega; f = 1.0\ kHz$	–	4.0	dB